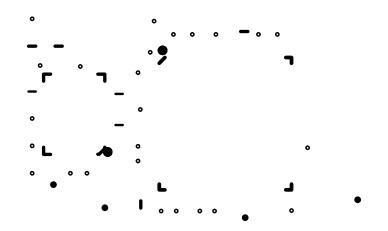








PRIMARY SILKSCREEN

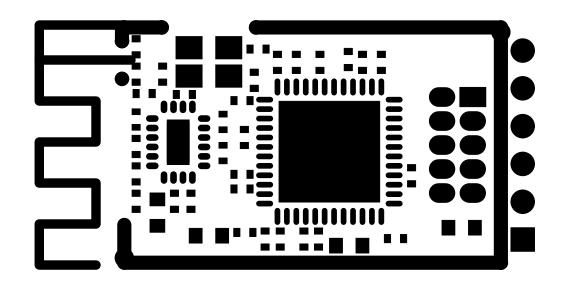








PRIMARY SOLDER MASK

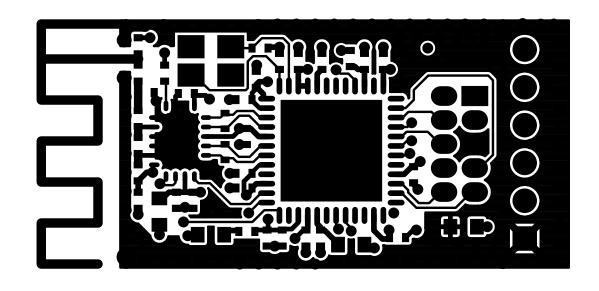








PRIMARY SIDE

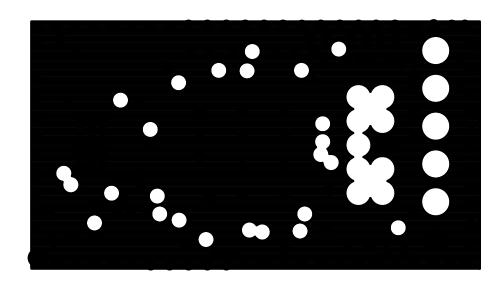








GROUND PLANE

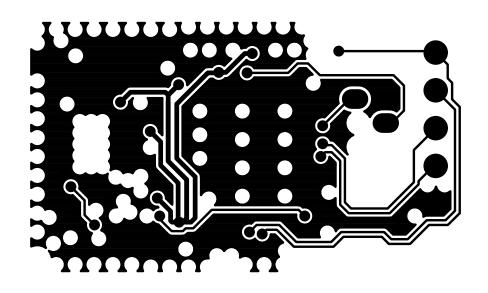








POWER PLANE

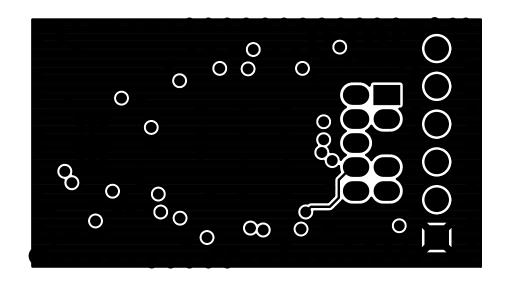








SECONDARY SIDE

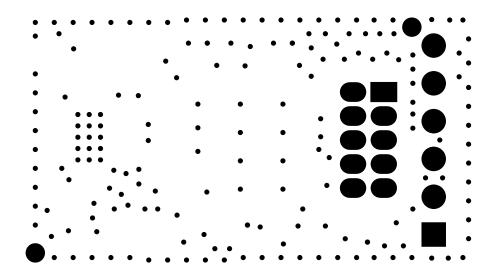








SECONDARY SOLDER MASK

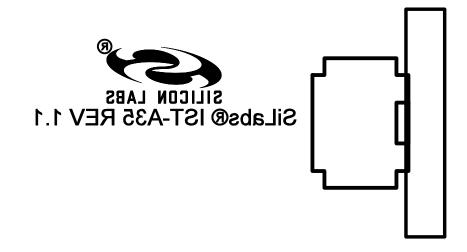






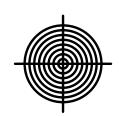


SECONDARY SILKSCREEN

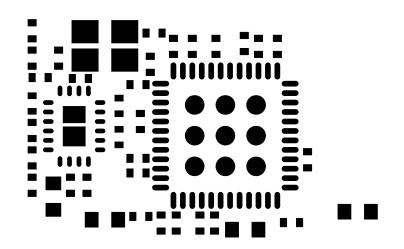




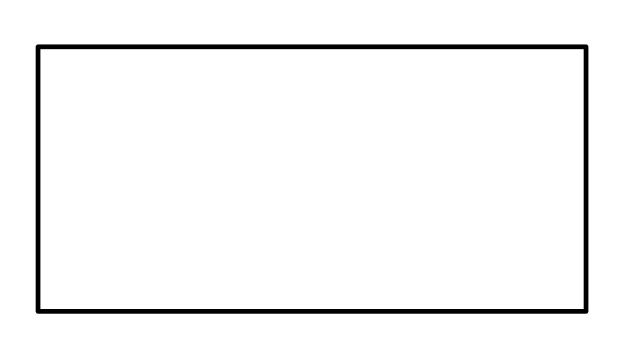


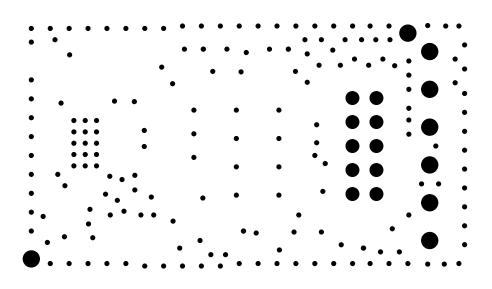


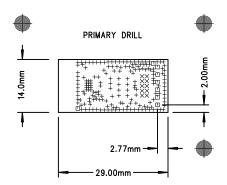
PRIMARY SOLDER PASTE











NOTES : UNLESS OTHERWISE SPECIFIED

- 1. MANUFACTURE IN ACCORDANCE WITH IPC-6012, TYPE 3, CLASS 2.
- END PRODUCT FEATURES SHALL NOT VARY MORE THAN 20% FROM ARTWORK ORIGINALS.
- 3. LAMINATE AND PREPREG SHALL BE AS PER IPC-4101/26,83,98 WITH A DECOMPOSITION TEMPERATURE >= 345°C, COLOR, NATURAL.
- 4. COPPER WEIGHT SHALL BE 0.5 OZ./SQ. FT. BEFORE PLATING.
- 5. ALL PLATED THROUGH HOLES SHALL HAVE A MINIMUM OF 0.001" COPPER.
- 6. DRILL HOLE TOLERANCE AFTER PLATING SHALL BE ±0.003".
- 7. MINIMUM ANNULAR RING SHALL BE 0.001".
- 8. MINIMUM ANNULAR RING AT EMERGENT CONDUCTORS SHALL BE 0.003".
- 9. FINAL PCB THICKNESS SHALL BE 0.031" ±10%.
- 10. WARP/TWIST SHALL NOT EXCEED 1.0%
- 11. FINISH SHALL BE LPI, BLACK SMOBC, ENIG BOTH SIDES.
- 12. SILKSCREEN WITH NONCONDUCTIVE WHITE EPOXY INK.
- 13. REFERENCE ADDITIONAL FAB NOTES IN FILE README.TXT

LAYER STACKUP	FILE NAMES
PRIMARY SILKSCREEN	A35_PSS.PHO
PRIMARY SOLDERMASK	A35_PSM.PHO
PRIMARY SIDE	A35_PRI.PHO
GROUND PLANE	A35_L02.PH0
POWER PLANE	A35_L03.PH0
SECONDARY SIDE	A35_SEC.PHO
SECONDARY SOLDERMASK	A35_SSM.PHO
SECONDARY SILKSCREEN	A35_SSS.PHO

SIZE	QTY	SYM	PLT	TOOL	TOL
0.25	179	+	Р	1	+0/-0.25
0.71	10	X	Р	2	+/-0.075
0.89	8		Р	3	+/-0.075

SCALE: NONE

UNLES	SS OTHERWISE SPECI	FIED				COMPANY	:		•	400 W Cesar	Chavez	
DIMENSIONS ARE	IN INCHES AND APP	LY AFTER FINISH	THIS DOCUME	ENT CONTAINS F				45		AUSTIN, TX 78	701	
INTERPR	ET DRAWING PER MIL	-D-1000	OR USED FOR	ANY PURPOSE	OTHER THAN			SILICON L	ABS	(512)416-8500 www.silabs.com		
	TOLERANCES					MAME.						
HOLE TOLERANCES PER 78027			IN WHOLE OR IN PART, WITHOUT THE WRITTEN CONSENT OF SILICON LABORATORIES, INC		NAME.		IST-A35			REV :		
DECIMALS	ANGLES	SURFACES	CONSENT OF	SILICUN LABORA	ATURIES, INC							1.1
.XX +/-	l ,	l /										
.XXX +/-	+/-	MICROINCHES	DESIGN	BK	02N0V2015	SIZE	PART NU	IMBER:				
PAR	T TO BE FREE OF B	URRS	LAYOUT	CT	03N0V2015	Δ						
BREAK EDGES	BEND RADIUS	BEND RELIEF				^			•			
MAX		— MAX	DO NOT	SCALE	DRAWING	SCAL	E 1:1	FABRIC	ATION	DRAWING	SHEET 1	1 OF 1

 	IST-A35 REV 1.1 Size:
	Array: 2.283465 x 3.255906 Part: 1.141732 x 0.551181
	Parts On Array: 10 Parts
	Matrix:
	2 x 5
	Spacing: 0.0 x 0.0
	Array Borders: Left: 0.0 Right: 0.0 Top: 0.25 Bottom: 0.25
	Top: 0.25 Bottom: 0.25

Notes:

Please add 4, 0.125" NP tooling holes located 0.125" from tab corners and 3, 40/120 fiduials to each side of array located 0.25" from tooling holes.